



Surface Mount Schottky Rectifier





Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

Mechanical Date

• Package: SOD-323FL

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

• Polarity: Cathode line denotes the cathode end

■Maximum Ratings (Ta=25 °C Unless otherwise specified)

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PARAMETER	SYMBOL	UNIT	FM16	FM110	FM115	FM120
Device marking code			FM16	FM110	FM115	FM120
Repetitive peak reverse voltage	V_{RRM}	٧	60	100	150	200
Average rectified output current @60Hz sine wave, Resistance load, TC (FIG.1)	Io	Α		1.	.0	
Surge(non-repetitive)forward current @ 60Hz half-sine wave,1 cycle, Tj=25℃		А	25			
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25℃	I _{FSM}		50			
Current squared time @1ms≲t≲8.3ms Tj =25℃,Rating of per diode	l ² t	A ² S		2	.6	
Typical junction capacitance @4V,1MHz	Cj	pF	40			
Storage temperature	T _{stg}	°		-55 ~	+175	
Junction temperature	Tj	°C	-55 ~+125 -55 ~+175			

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

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PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	FM16	FM110	FM115	FM120
Peak Forward Voltage	V _F	٧	I _{FM} =1.0A	0.70	0.85	0.	90
Maximum DC reverse current at rated DC blocking voltage	1	m 1	T _j =25°C		0	.20	
per diode @ VRM=VRRM	IRRM	mA	T _j =125°C	30			

Note1:Pulse test:300uS pulse widh,1% duty cycle

Note2:Pulse test:pulse widh 40mS

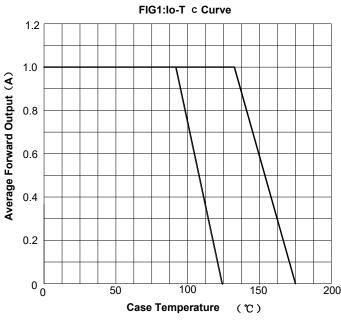
FM16 THRU FM120

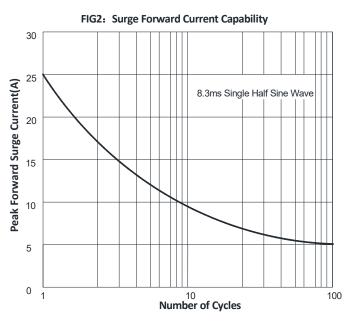
■Thermal Characteristics (Ta=25 °C Unless otherwise specified)

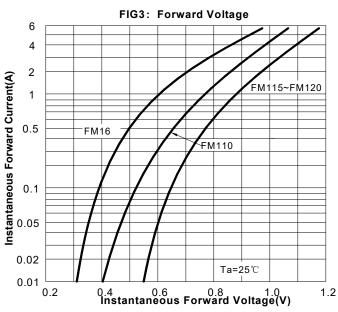
PARAMETER	SYMBOL	UNIT	FM16	FM110	FM115	FM120	
Thermal Resistance	R _{θJ-A}	°C 0.01	90 ¹⁾				
mermai Resistance	R _{θJ-C}	°C/W	46 ¹⁾				

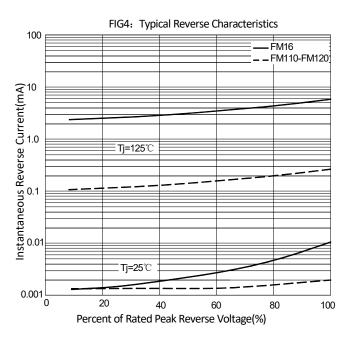
Note:

■ Characteristics (Typical)





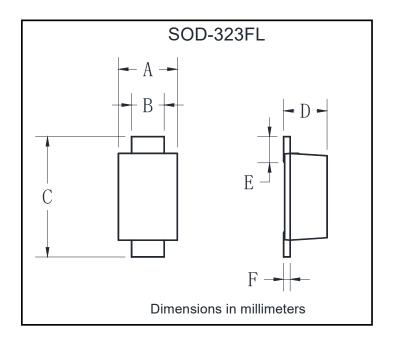




⁽¹⁾ Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm*3mm copper pad areas.

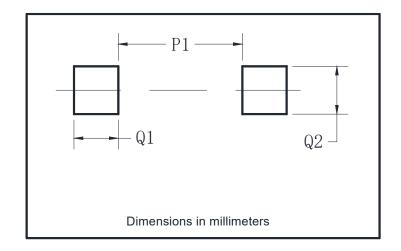


■ Outline Dimensions



SOD-323FL					
Dim	Min	Max			
Α	1.05	1.45			
В	0.90	1.15			
С	2.30	2.70			
D	0.80	1.20			
E	0.25	0.70			
F	0.05	0.25			

■ Suggested pad layout



SOD-323FL			
Dim	Millimeters		
P1	1.30		
Q1	1.00		
Q2	1.50		



FM16 THRU FM120

Disclaimer

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